

MAX7219/MAX7221 Serially Interfaced, 8-Digit LED Display Drivers

General Description

The MAX7219/MAX7221 are compact, serial input/output common-cathode display drivers that interface microprocessors (μ Ps) to 7-segment numeric LED displays of up to 8 digits, bar-graph displays, or 64 individual LEDs. Included on-chip are a BCD code-B decoder, multiplex scan circuitry, segment and digit drivers, and an 8x8 static RAM that stores each digit. Only one external resistor is required to set the segment current for all LEDs. The MAX7221 is compatible with SPI™, QSPI™, and MICROWIRE™, and has slew-rate-limited segment drivers to reduce EMI.

A convenient 4-wire serial interface connects to all common μ Ps. Individual digits may be addressed and updated without rewriting the entire display. The MAX7219/MAX7221 also allow the user to select code-B decoding or no-decode for each digit.

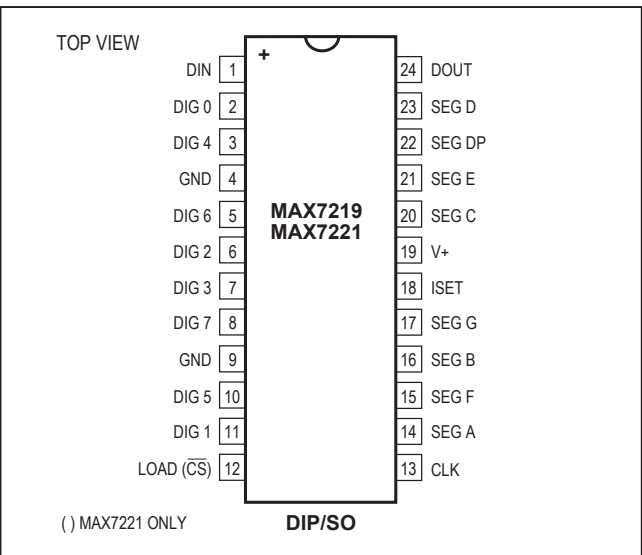
The devices include a 150 μ A low-power shutdown mode, analog and digital brightness control, a scan-limit register that allows the user to display from 1 to 8 digits, and a test mode that forces all LEDs on.

For applications requiring 3V operation or segment blinking, refer to the MAX6951 data sheet.

Applications

- Bar-Graph Displays
- Industrial Controllers
- Panel Meters
- LED Matrix Displays

Pin Configuration



Features

- 10MHz Serial Interface
- Individual LED Segment Control
- Decode/No-Decode Digit Selection
- 150 μ A Low-Power Shutdown (Data Retained)
- Digital and Analog Brightness Control
- Display Blanked on Power-Up
- Drive Common-Cathode LED Display
- Slew-Rate Limited Segment Drivers for Lower EMI (MAX7221)
- SPI, QSPI, MICROWIRE Serial Interface (MAX7221)
- 24-Pin DIP and SO Packages

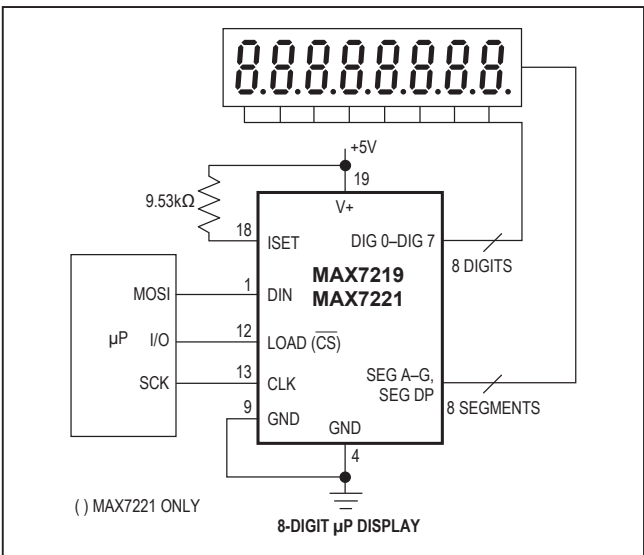
Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX7219CNG	0°C to +70°C	24 Narrow Plastic DIP
MAX7219CWG	0°C to +70°C	24 Wide SO
MAX7219C/D	0°C to +70°C	Dice*
MAX7219ENG	-40°C to +85°C	24 Narrow Plastic DIP
MAX7219EWG	-40°C to +85°C	24 Wide SO
MAX7219ERG	-40°C to +85°C	24 Narrow Cerdip

Ordering Information continued at end of data sheet.

*Dice are specified at $T_A = +25^\circ\text{C}$.

Typical Application Circuit



SPI and QSPI are trademarks of Motorola Inc. MICROWIRE is a trademark of National Semiconductor Corp.

Absolute Maximum Ratings

Voltage (with respect to GND)

V+	-0.3V to 6V
DIN, CLK, LOAD, CS	-0.3V to 6V
All Other Pins	-0.3V to (V+ + 0.3V)

Current

DIG 0–DIG 7 Sink Current	500mA
SEG A–G, DP Source Current	100mA

Continuous Power Dissipation ($T_A = +85^\circ\text{C}$)

Narrow Plastic DIP (derate 13.3mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$)	1066mW
Wide SO (derate 11.8mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$)	941mW
Narrow Cerdip (derate 12.5mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$)	1000mW

Operating Temperature Ranges (T_{MIN} to T_{MAX})

MAX7219C_G/MAX7221C_G	0°C to $+70^\circ\text{C}$
MAX7219E_G/MAX7221E_G	-40°C to $+85^\circ\text{C}$
Storage Temperature Range	-65°C to $+160^\circ\text{C}$
Lead Temperature (soldering, 10s)	$+300^\circ\text{C}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Electrical Characteristics

($V_+ = 5\text{V} \pm 10\%$, $R_{\text{SET}} = 9.53\text{k}\Omega \pm 1\%$, $T_A = T_{\text{MIN}}$ to T_{MAX} , unless otherwise noted.)

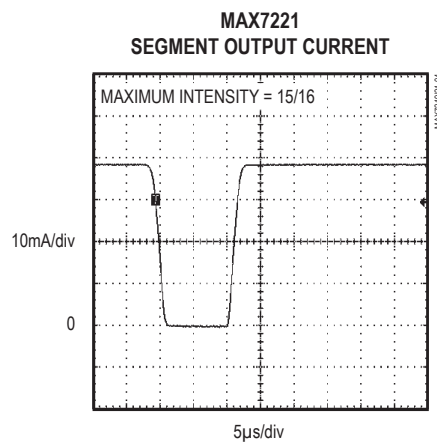
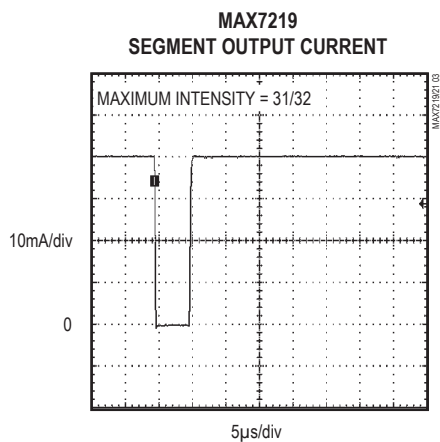
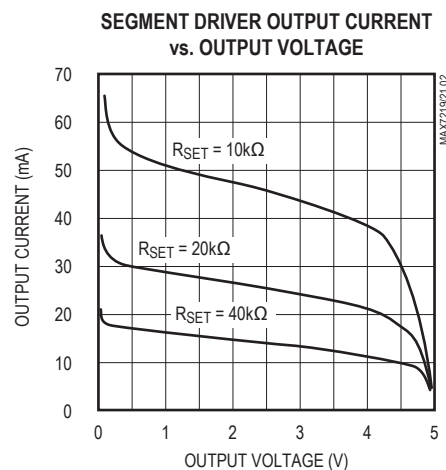
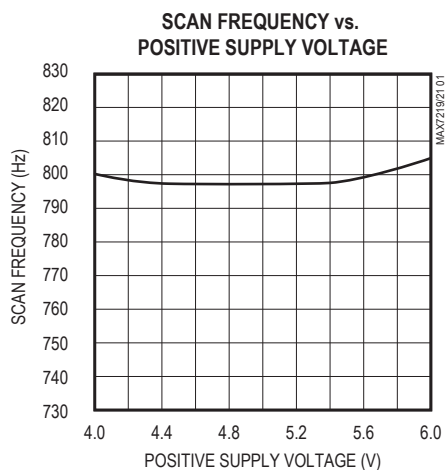
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Supply Voltage	V_+		4.0		5.5	V
Shutdown Supply Current	I_+	All digital inputs at V_+ or GND, $T_A = +25^\circ\text{C}$			150	μA
Operating Supply Current	I_+	$R_{\text{SET}} = \text{open circuit}$			8	mA
		All segments and decimal point on, $I_{\text{SEG}_-} = -40\text{mA}$		330		
Display Scan Rate	f_{OSC}	8 digits scanned	500	800	1300	Hz
Digit Drive Sink Current	I_{DIGIT}	$V_+ = 5\text{V}$, $V_{\text{OUT}} = 0.65\text{V}$	320			mA
Segment Drive Source Current	I_{SEG}	$T_A = +25^\circ\text{C}$, $V_+ = 5\text{V}$, $V_{\text{OUT}} = (V_+ - 1\text{V})$	-30	-40	-45	mA
Segment Current Slew Rate (MAX7221 only)	$\Delta I_{\text{SEG}}/\Delta t$	$T_A = +25^\circ\text{C}$, $V_+ = 5\text{V}$, $V_{\text{OUT}} = (V_+ - 1\text{V})$	10	20	50	mA/ μs
Segment Drive Current Matching	ΔI_{SEG}			3.0		%
Digit Drive Leakage (MAX7221 only)	I_{DIGIT}	Digit off, $V_{\text{DIGIT}} = V_+$			-10	μA
Segment Drive Leakage (MAX7221 only)	I_{SEG}	Segment off, $V_{\text{SEG}} = 0\text{V}$			1	μA
Digit Drive Source Current (MAX7219 only)	I_{DIGIT}	Digit off, $V_{\text{DIGIT}} = (V_+ - 0.3\text{V})$	-2			mA
Segment Drive Sink Current (MAX7219 only)	I_{SEG}	Segment off, $V_{\text{SEG}} = 0.3\text{V}$	5			mA

Electrical Characteristics (continued)(V₊ = 5V ±10%, R_{SET} = 9.53kΩ ±1%, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
LOGIC INPUTS						
Input Current DIN, CLK, LOAD, $\overline{\text{CS}}$	I _{IH} , I _{IL}	V _{IN} = 0V or V ₊	-1		1	μA
Logic High Input Voltage	V _{IH}		3.5			V
Logic Low Input Voltage	V _{IL}				0.8	V
Output High Voltage	V _{OH}	DOUT, I _{SOURCE} = -1mA	V ₊ - 1			V
Output Low Voltage	V _{OL}	DOUT, I _{SINK} = 1.6mA			0.4	V
Hysteresis Voltage	ΔV _I	DIN, CLK, LOAD, $\overline{\text{CS}}$		1		V
TIMING CHARACTERISTICS						
CLK Clock Period	t _{CP}		100			ns
CLK Pulse Width High	t _{CH}		50			ns
CLK Pulse Width Low	t _{CL}		50			ns
$\overline{\text{CS}}$ Fall to SCLK Rise Setup Time (MAX7221 only)	t _{CSS}		25			ns
CLK Rise to $\overline{\text{CS}}$ or LOAD Rise Hold Time	t _{CSH}		0			ns
DIN Setup Time	t _{DS}		25			ns
DIN Hold Time	t _{DH}		0			ns
Output Data Propagation Delay	t _{DO}	C _{LOAD} = 50pF			25	ns
Load-Rising Edge to Next Clock Rising Edge (MAX7219 only)	t _{LDCK}		50			ns
Minimum $\overline{\text{CS}}$ or LOAD Pulse High	t _{CSW}		50			ns
Data-to-Segment Delay	t _{DSPD}				2.25	ms

Typical Operating Characteristics

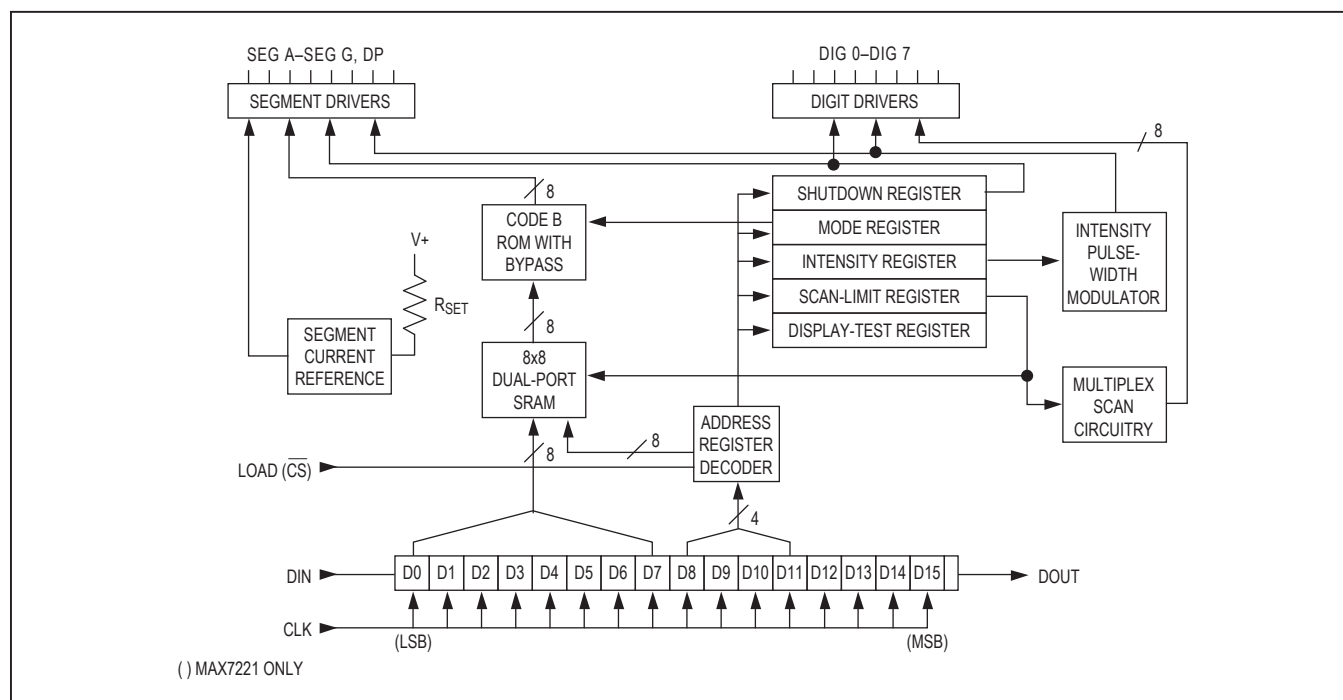
($V_+ = +5V$, $T_A = +25^\circ C$, unless otherwise noted.)



Pin Description

PIN	NAME	FUNCTION
1	DIN	Serial-Data Input. Data is loaded into the internal 16-bit shift register on CLK's rising edge.
2, 3, 5–8, 10, 11	DIG 0–DIG 7	Eight-digit drive lines that sink current from the display common cathode. The MAX7219 pulls the digit outputs to V+ when turned off. The MAX7221's digit drivers are high-impedance when turned off.
4, 9	GND	Ground. Both GND pins must be connected.
12	LOAD (MAX7219)	Load-Data Input. The last 16 bits of serial data are latched on LOAD's rising edge.
	$\overline{\text{CS}}$ (MAX7221)	Chip-Select Input. Serial data is loaded into the shift register while $\overline{\text{CS}}$ is low. The last 16 bits of serial data are latched on $\overline{\text{CS}}$'s rising edge.
13	CLK	Serial-Clock Input. 10MHz maximum rate. On CLK's rising edge, data is shifted into the internal shift register. On CLK's falling edge, data is clocked out of DOUT. On the MAX7221, the CLK input is active only while $\overline{\text{CS}}$ is low.
14–17, 20–23	SEG A–SEG G, DP	Seven Segment Drives and Decimal Point Drive that source current to the display. On the MAX7219, when a segment driver is turned off it is pulled to GND. The MAX7221 segment drivers are high-impedance when turned off.
18	ISSET	Connect to V _{DD} through a resistor (R _{SET}) to set the peak segment current (Refer to <i>Selecting R_{SET} Resistor and Using External Drivers</i> section).
19	V+	Positive Supply Voltage. Connect to +5V.
24	DOUT	Serial-Data Output. The data into DIN is valid at DOUT 16.5 clock cycles later. This pin is used to daisy-chain several MAX7219/MAX7221's and is never high-impedance.

Functional Diagram



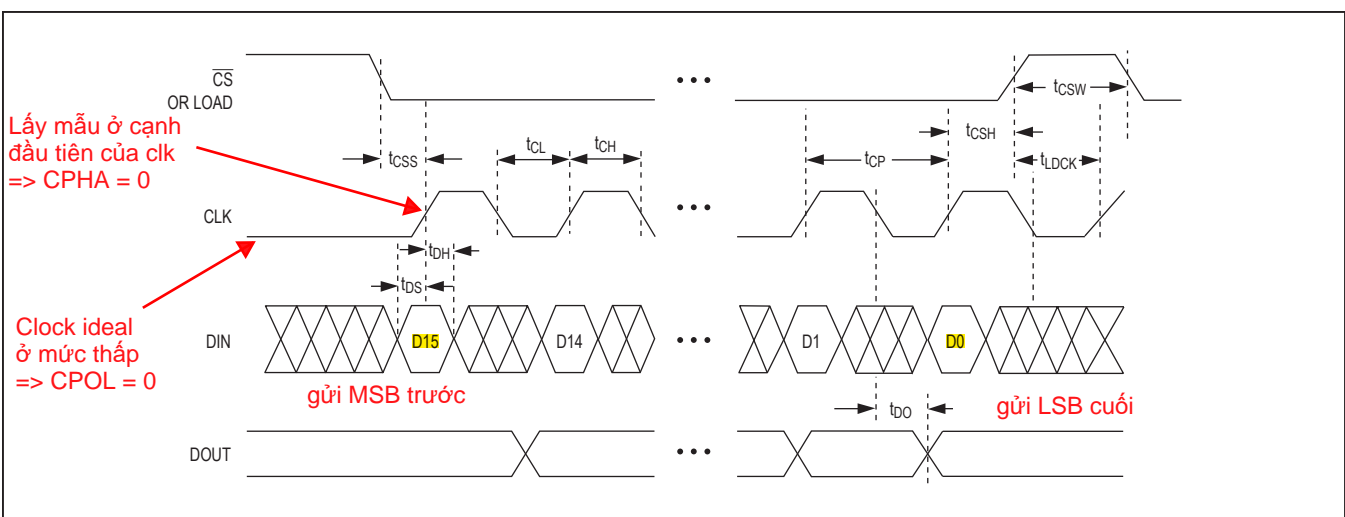


Figure 1. Timing Diagram

Table 1. Serial-Data Format (16 Bits)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
X	X	X	X	ADDRESS				MSB	DATA						LSB

Detailed Description

MAX7219/MAX7221 Differences

The MAX7219 and MAX7221 are identical except for two parameters: the MAX7221 segment drivers are slew-rate limited to reduce electromagnetic interference (EMI), and its serial interface is fully SPI compatible.

Serial-Addressing Modes

For the MAX7219, serial data at DIN, sent in 16-bit packets, is shifted into the internal 16-bit shift register with each rising edge of CLK regardless of the state of LOAD. For the MAX7221, \overline{CS} must be low to clock data in or out. The data is then latched into either the digit or control registers on the rising edge of LOAD/ \overline{CS} . LOAD/ \overline{CS} must go high concurrently with or after the 16th rising clock edge, but before the next rising clock edge or data will be lost. Data at DIN is propagated through the shift register and appears at DOUT 16.5 clock cycles later. Data is clocked out on the falling edge of CLK. Data bits are labeled D0–D15 (Table 1). D8–D11 contain the register address. D0–D7 contain the data, and D12–D15 are “don’t care” bits. The first received is D15, the most significant bit (MSB).

8bit data frame
CPHA và CPOL = 0
gửi MSB trước
baudrate lên tới 10MHz

Digit and Control Registers

Table 2 lists the 14 addressable digit and control registers. The digit registers are realized with an on-chip, 8x8 dual-port SRAM. They are addressed directly so that individual digits can be updated and retain data as long as V+ typically exceeds 2V. The control registers consist of decode mode, display intensity, scan limit (number of scanned digits), shutdown, and display test (all LEDs on).

Shutdown Mode

When the MAX7219 is in shutdown mode, the scan oscillator is halted, all segment current sources are pulled to ground, and all digit drivers are pulled to V+, thereby blanking the display. The MAX7221 is identical, except the drivers are high-impedance. Data in the digit and control registers remains unaltered. Shutdown can be used to save power or as an alarm to flash the display by successively entering and leaving shutdown mode. For minimum supply current in shutdown mode, logic inputs should be at ground or V+ (CMOS-logic levels).

Typically, it takes less than 250μs for the MAX7219/MAX7221 to leave shutdown mode. The display driver can be programmed while in shutdown mode, and shutdown mode can be overridden by the display-test function.

Table 2. Register Address Map

REGISTER	ADDRESS					HEX CODE
	D15–D12	D11	D10	D9	D8	
No-Op	X	0	0	0	0	0xX0
Digit 0	X	0	0	0	1	0xX1
Digit 1	X	0	0	1	0	0xX2
Digit 2	X	0	0	1	1	0xX3
Digit 3	X	0	1	0	0	0xX4
Digit 4	X	0	1	0	1	0xX5
Digit 5	X	0	1	1	0	0xX6
Digit 6	X	0	1	1	1	0xX7
Digit 7	X	1	0	0	0	0xX8
Decode Mode	X	1	0	0	1	0xX9
Intensity	X	1	0	1	0	0xXA
Scan Limit	X	1	0	1	1	0xXB
Shutdown	X	1	1	0	0	0xXC
Display Test	X	1	1	1	1	0xFF

Initial Power-Up

On initial power-up, all control registers are reset, the display is blanked, and the MAX7219/MAX7221 enter shutdown mode. Program the display driver prior to display use. Otherwise, it will initially be set to scan one digit, it will not decode data in the data registers, and the intensity register will be set to its minimum value.

Decode-Mode Register

The decode-mode register sets BCD code B (0-9, E, H, L, P, and -) or no-decode operation for each digit. Each bit in the register corresponds to one digit. A logic high selects code B decoding while logic low bypasses the decoder. Examples of the decode mode control-register format are shown in Table 4.

When the code B decode mode is used, the decoder looks only at the lower nibble of the data in the digit registers (D3–D0), disregarding bits D4–D6. D7, which sets the decimal point (SEG DP), is independent of the decoder and is positive logic (D7 = 1 turns the decimal point on). Table 5 lists the code B font.

When no-decode is selected, data bits D7–D0 correspond to the segment lines of the MAX7219/MAX7221. Table 6 shows the one-to-one pairing of each data bit to the appropriate segment line.

Table 3. Shutdown Register Format (Address (Hex) = 0xXC)

MODE	ADDRESS CODE (HEX)	REGISTER DATA							
		D7	D6	D5	D4	D3	D2	D1	D0
Shutdown Mode	0xXC	X	X	X	X	X	X	X	X
Normal Operation	0xXC	X	X	X	X	X	X	X	1

Table 4. Decode-Mode Register Examples (Address (Hex) = 0xX9)

DECODE MODE	REGISTER DATA								HEX CODE
	D7	D6	D5	D4	D3	D2	D1	D0	
No decode for digits 7–0	0	0	0	0	0	0	0	0	0x00
Code B decode for digit 0 No decode for digits 7–1	0	0	0	0	0	0	0	1	0x01
Code B decode for digits 3–0 No decode for digits 7–4	0	0	0	0	1	1	1	1	0x0F
Code B decode for digits 7–0	1	1	1	1	1	1	1	1	0xFF

bit nào được set thành 1 thì hàng đó (đối với led ma trận) hoặc số nằm ở vị trí đó (đối với led 7 đoạn) sẽ được bật decode nếu được reset về 0 thì không bật decode

Table 5. Code B Font

nhập giá trị trong cột REGISTER DATA để hiện kí tự với Decode Mode
nếu set bit7 lên 1 thì sẽ có thêm dấu chấm

7-SEGMENT CHARACTER	REGISTER DATA						ON SEGMENTS = 1							
	D7*	D6-D4	D3	D2	D1	D0	DP*	A	B	C	D	E	F	G
0		X	0	0	0	0		1	1	1	1	1	1	0
1		X	0	0	0	1		0	1	1	0	0	0	0
2		X	0	0	1	0		1	1	0	1	1	0	1
3		X	0	0	1	1		1	1	1	1	0	0	1
4		X	0	1	0	0		0	1	1	0	0	1	1
5		X	0	1	0	1		1	0	1	1	0	1	1
6		X	0	1	1	0		1	0	1	1	1	1	1
7		X	0	1	1	1		1	1	1	0	0	0	0
8		X	1	0	0	0		1	1	1	1	1	1	1
9		X	1	0	0	1		1	1	1	1	0	1	1
—		X	1	0	1	0		0	0	0	0	0	0	1
E		X	1	0	1	1		1	0	0	1	1	1	1
H		X	1	1	0	0		0	1	1	0	1	1	1
L		X	1	1	0	1		0	0	0	1	1	1	0
P		X	1	1	1	0		1	1	0	0	1	1	1
blank		X	1	1	1	1		0	0	0	0	0	0	0

*The decimal point is set by bit D7 = 1

Table 6. No-Decode Mode Data Bits and Corresponding Segment Lines

STANDARD 7-SEGMENT LED

	REGISTER DATA							
	D7	D6	D5	D4	D3	D2	D1	D0
Corresponding Segment Line	DP	A	B	C	D	E	F	G

Intensity Control and Interdigit Blanking

The MAX7219/MAX7221 allow display brightness to be controlled with an external resistor (R_{SET}) connected between $V+$ and ISET. The peak current sourced from the segment drivers is nominally 100 times the current entering ISET. This resistor can either be fixed or variable to allow brightness adjustment from the front panel. Its minimum value should be 9.53k Ω , which typically sets the segment current at 40mA. Display brightness can also be controlled digitally by using the intensity register.

Digital control of display brightness is provided by an internal pulse-width modulator, which is controlled by the lower nibble of the intensity register. The modulator scales the average segment current in 16 steps from a maximum of 31/32 down to 1/32 of the peak current set by R_{SET} (15/16 to 1/16 on MAX7221). Table 7 lists the intensity register format. The minimum interdigit blanking time is set to 1/32 of a cycle.

Table 7. Intensity Register Format (Address (Hex) = 0xA)

DUTY CYCLE		D7	D6	D5	D4	D3	D2	D1	D0	HEX CODE
MAX7219	MAX7221									
1/32 (min on)	1/16 (min on)	X	X	X	X	0	0	0	0	0x0
3/32	2/16	X	X	X	X	0	0	0	1	0x1
5/32	3/16	X	X	X	X	0	0	1	0	0x2
7/32	4/16	X	X	X	X	0	0	1	1	0x3
9/32	5/16	X	X	X	X	0	1	0	0	0x4
11/32	6/16	X	X	X	X	0	1	0	1	0x5
13/32	7/16	X	X	X	X	0	1	1	0	0x6
15/32	8/16	X	X	X	X	0	1	1	1	0x7
17/32	9/16	X	X	X	X	1	0	0	0	0x8
19/32	10/16	X	X	X	X	1	0	0	1	0x9
21/32	11/16	X	X	X	X	1	0	1	0	0xA
23/32	12/16	X	X	X	X	1	0	1	1	0xB
25/32	13/16	X	X	X	X	1	1	0	0	0xC
27/32	14/16	X	X	X	X	1	1	0	1	0xD
29/32	15/16	X	X	X	X	1	1	1	0	0xE
31/32	15/16 (max on)	X	X	X	X	1	1	1	1	0xF

Table 8. Scan-Limit Register Format (Address (Hex) = 0xB)

SCAN LIMIT	REGISTER DATA								HEX CODE
	D7	D6	D5	D4	D3	D2	D1	D0	
Display digit 0 only*	X	X	X	X	X	0	0	0	0x0
Display digits 0 & 1*	X	X	X	X	X	0	0	1	0x1
Display digits 0 1 2*	X	X	X	X	X	0	1	0	0x2
Display digits 0 1 2 3	X	X	X	X	X	0	1	1	0x3
Display digits 0 1 2 3 4	X	X	X	X	X	1	0	0	0x4
Display digits 0 1 2 3 4 5	X	X	X	X	X	1	0	1	0x5
Display digits 0 1 2 3 4 5 6	X	X	X	X	X	1	1	0	0x6
Display digits 0 1 2 3 4 5 6 7	X	X	X	X	X	1	1	1	0x7

*See Scan-Limit Register section for application.

Scan-Limit Register

The scan-limit register sets how many digits are displayed, from 1 to 8. They are displayed in a multiplexed manner with a typical display scan rate of 800Hz with 8 digits displayed. If fewer digits are displayed, the scan rate is

$8f_{OSC}/N$, where **N is the number of digits scanned**. Since the number of scanned digits affects the display brightness, the scan-limit register should not be used to blank portions of the display (such as leading zero suppression). Table 8 lists the scan-limit register format.

If the scan-limit register is set for three digits or less, individual digit drivers will dissipate excessive amounts of power. Consequently, the value of the R_{SET} resistor must be adjusted according to the number of digits displayed, to limit individual digit driver power dissipation. Table 9 lists the number of digits displayed and the corresponding maximum recommended segment current when the digit drivers are used.

Display-Test Register

The display-test register operates in two modes: normal and display test. Display-test mode turns all LEDs on by overriding, but not altering, all controls and digit registers (including the shutdown register). In display-test mode, 8 digits are scanned and the duty cycle is 31/32 (15/16 for MAX7221). Table 10 lists the display-test register format.

Table 9. Maximum Segment Current for 1-, 2-, or 3-Digit Displays

NUMBER OF DIGITS DISPLAYED	MAXIMUM SEGMENT CURRENT (mA)
1	10
2	20
3	30

Table 10. Display-Test Register Format (Address (Hex) = 0xXF)

MODE	REGISTER DATA							
	D7	D6	D5	D4	D3	D2	D1	D0
Normal Operation	X	X	X	X	X	X	X	0
Display Test Mode	X	X	X	X	X	X	X	1

Note: The MAX7219/MAX7221 remain in display-test mode (all LEDs on) until the display-test register is reconfigured for normal operation.

No-Op Register

The no-op register is used when cascading MAX7219s or MAX7221s. Connect all devices' LOAD/ \overline{CS} inputs together and connect DOUT to DIN on adjacent devices. DOUT is a CMOS logic-level output that easily drives DIN of successively cascaded parts. (Refer to the *Serial Addressing Modes* section for detailed information on serial input/output timing.) For example, if four MAX7219s

are cascaded, then to write to the fourth chip, sent the desired 16-bit word, followed by three no-op codes (hex 0xX0XX, see Table 2). When LOAD/ \overline{CS} goes high, data is latched in all devices. The first three chips receive no-op commands, and the fourth receives the intended data.

Applications Information

Supply Bypassing and Wiring

To minimize power-supply ripple due to the peak digit driver currents, connect a 10 μ F electrolytic and a 0.1 μ F ceramic capacitor between V+ and GND as close to the device as possible. The MAX7219/MAX7221 should be placed in close proximity to the LED display, and connections should be kept as short as possible to minimize the effects of wiring inductance and electro-magnetic interference. Also, both GND pins must be connected to ground.

Selecting R_{SET} Resistor and Using External Drivers

The current per segment is approximately 100 times the current in ISET. To select R_{SET} , see Table 11. The MAX7219/MAX7221's maximum recommended segment current is 40mA. For segment current levels above these levels, external digit drivers will be needed. In this application, the MAX7219/MAX7221 serve only as controllers for other high-current drivers or transistors. Therefore, to conserve power, use $R_{SET} = 47k\Omega$ when using external current sources as segment drivers.

The example in Figure 2 uses the MAX7219/MAX7221's segment drivers, a MAX394 single-pole double-throw analog switch, and external transistors to drive 2.3" AND2307SLC common-cathode displays. The 5.6V zener diode has been added in series with the decimal point LED because the decimal point LED forward voltage is typically 4.2V. For all other segments the LED forward voltage is typically 8V. Since external transistors are used to sink current (DIG 0 and DIG 1 are used as logic switches), peak segment currents of 45mA are allowed even though only two digits are displayed. In applications where the MAX7219/MAX7221's digit drivers are used to sink current and fewer than four digits are displayed, Table 9 specifies the maximum allowable segment current. R_{SET} must be selected accordingly (Table 11).

Refer to the *Continuous Power Dissipation* section of the *Absolute Maximum Ratings* to calculate acceptable limits for ambient temperature, segment current, and the LED forward-voltage drop.

Table 11. R_{SET} vs. Segment Current and LED Forward Voltage

I_{SEG} (mA)	V_{LED} (V)				
	1.5	2.0	2.5	3.0	3.5
40	12.2	11.8	11.0	10.6	9.69
30	17.8	17.1	15.8	15.0	14.0
20	29.8	28.0	25.9	24.5	22.6
10	66.7	63.7	59.3	55.4	51.2

Note: R_{SET} values are in Kilo Ohms (k Ω)

Computing Power Dissipation

The upper limit for power dissipation (PD) for the MAX7219/MAX7221 is determined from the following equation:

$$PD = (V+ \times 8mA) + (V+ - V_{LED})(DUTY \times I_{SEG} \times N)$$

where:

$V+$ = supply voltage

DUTY = duty cycle set by intensity register

N = number of segments driven (worst case is 8)

V_{LED} = LED forward voltage

I_{SEG} = segment current set by R_{SET}

Dissipation example:

$I_{SEG} = 40mA$, $N = 8$, DUTY = 31/32, $V_{LED} = 1.8V$ at 40mA, $V+ = 5.25V$

$$PD = (5.25V \times 8mA) + (5.25V - 1.8V)(31/32 \times 40mA \times 8) = 1.11W$$

Thus, for a Cerdip package ($\theta_{JA} = +80^{\circ}C/W$ from Table 12), the maximum allowed ambient temperature T_A is given by:

$$T_{J(MAX)} = T_A + PD \times \theta_{JA}$$

$$150^{\circ}C = T_A + 1.11W \times 80^{\circ}C/W$$

where $T_A = +61.2^{\circ}C$.

The T_A limits for PDIP and SO packages in the dissipation example above are $+66.7^{\circ}C$ and $+55.6^{\circ}C$, respectively.

Table 12. Package Thermal Resistance Data

PACKAGE	THERMAL RESISTANCE (θ_{JA})
24 Narrow DIP	$+75^{\circ}C/W$
24 Wide SO	$+85^{\circ}C/W$
24 Cerdip	$+80^{\circ}C/W$
Maximum Junction Temperature (T_J) = $+150^{\circ}C$	
Maximum Ambient Temperature (T_A) = $+85^{\circ}C$	

Cascading Drivers

The example in Figure 3 drives 16 digits using a 3-wire μP interface. If the number of digits is not a multiple of 8, set both drivers' scan limits registers to the same number so one display will not appear brighter than the other. For example, if 12 digits are need, use 6 digits per display with both scan-limit registers set for 6 digits so that both displays have a 1/6 duty cycle per digit. If 11 digits are needed, set both scan-limit registers for 6 digits and leave one digit driver unconnected. If one display for 6 digits and the other for 5 digits, the second display will appear brighter because its duty cycle per digit will be 1/5 while the first display's will be 1/6. Refer to the *No-Op Register* section for additional information.

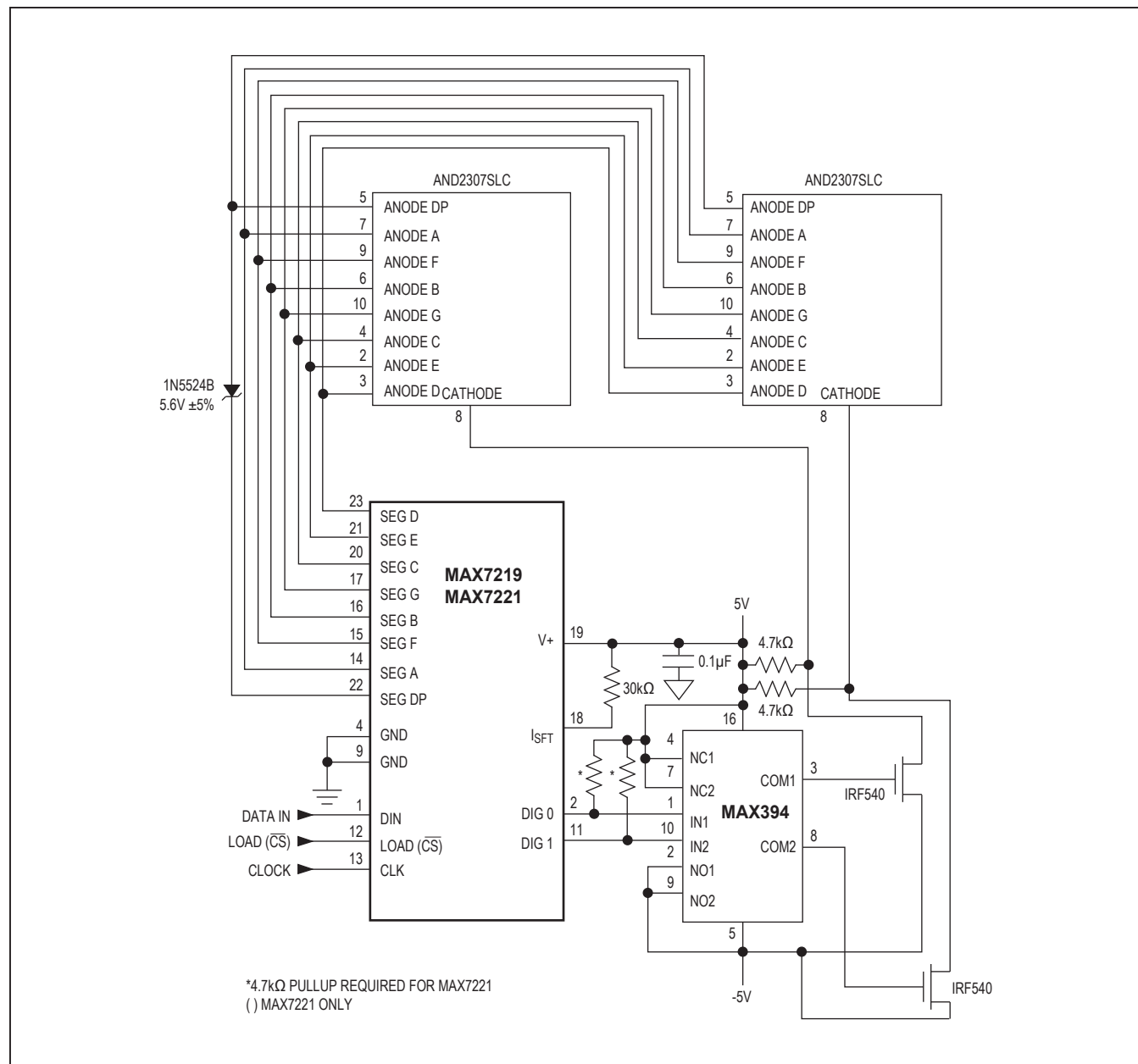
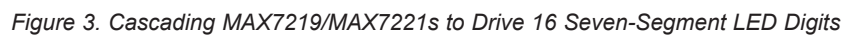


Figure 2. MAX7219/MAX7221 Driving 2.3in Displays



Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE
MAX7221CNG	0°C to +70°C	24 Narrow Plastic DIP
MAX7221CWG	0°C to +70°C	24 Wide SO
MAX7221C/D	0°C to +70°C	Dice*
MAX7221ENG	-40°C to +85°C	24 Narrow Plastic DIP
MAX7221EWG	-40°C to +85°C	24 Wide SO
MAX7221ERG	-40°C to +85°C	24 Narrow Cerdip

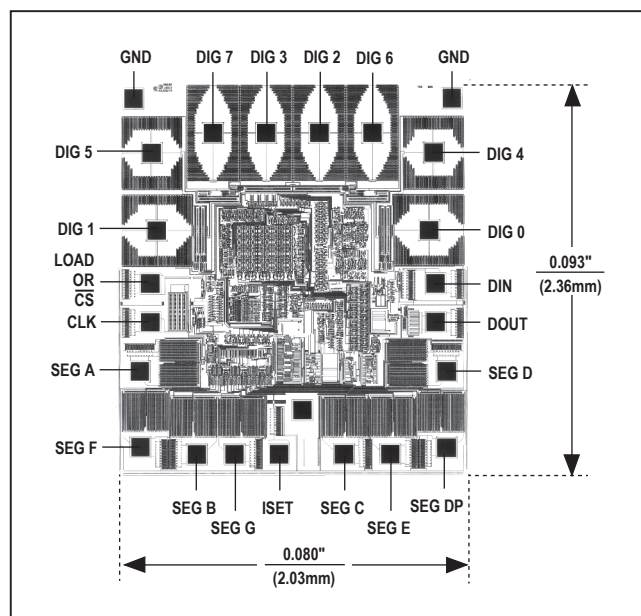
*Dice are specified at $T_A = +25^{\circ}\text{C}$.

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
24 PDIP	N24+1	21-0043	—
24 SOIC	W24+1	21-0042	90-0182

Chip Topography



TRANSISTOR COUNT: 5267

SUBSTRATE CONNECTED TO GND

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
5	8/19	Updated <i>No-Op Register</i> section	10
6	8/21	Added Note to Table 11 and updated <i>Package Information</i> section	11, 14

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